



## **PTC thermistors for overcurrent protection**

Leaded disks, coated, 12 V

**Series/Type:**      **B599\*5**  
**Date:**              June 2011

## Overcurrent protection

### Leaded disks, coated, 12 V

C935 ... C995

#### Applications

- Overcurrent protection
- Short circuit protection

#### Features

- Lead-free terminals
- Manufacturer's logo and type designation stamped on in yellow
- Low resistance
- For rated currents of up to 2.1 A
- High thermal stability
- UL approval to UL 1434 (file number E69802)
- VDE approval (license number 104843 E)
- RoHS-compatible

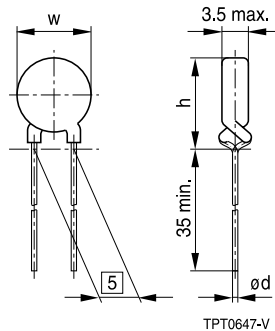
#### Options

- Leadless disks and leaded disks without coating available on request
- Thermistors with diameter  $w \leq 11.0$  mm are also available on tape (to IEC 60286-2)

#### Delivery mode

- Cardboard strips (standard)
- Cardboard tape reeled or in Ammo pack on request

#### Dimensional drawing



#### Dimensions (mm)

Type	$w_{\max}$	$h_{\max}$	$\varnothing d$
C935	22.0	25.5	0.6
C945	17.5	21.0	0.6
C955	13.5	17.0	0.6
C965	11.0	14.5	0.6
C975	9.0	12.5	0.6
C985	6.5	10.0	0.6
C995	4.0	7.5	0.5

#### General technical data



Max. operating voltage	$(T_A = 60\text{ }^{\circ}\text{C})$	$V_{\max}$	20	V DC or V AC
Rated voltage		$V_R$	12	V DC or V AC
Switching cycles		N	100	
Reference temperature	(typ.)	$T_{\text{ref}}$	160	$^{\circ}\text{C}$
Tolerance of $R_R$		$\Delta R_R$	$\pm 25$	%
Operating temperature range	$(V = 0)$	$T_{\text{op}}$	$-40/+125$	$^{\circ}\text{C}$
Operating temperature range	$(V = V_{\max})$	$T_{\text{op}}$	$-40/+85$	$^{\circ}\text{C}$

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### Electrical specifications and ordering codes

Type	$I_R$ mA	$I_S$ mA	$I_{Smax}$ ( $V = V_{max}$ ) A	$I_r$ (typ.) ( $V = V_{max}$ ) mA	$I_r$ (typ.) ( $V = V_R$ ) mA	$R_R$ $\Omega$	$R_{min}$ $\Omega$	Approvals  		Ordering code
C935	2100	4150	10.0	240	380	0.3	0.2	X	—	B59935C0160A070
C945	1500	3050	8.0	170	270	0.45	0.3	X	—	B59945C0160A070
C955	950	1900	5.5	120	190	0.8	0.5	X	—	B59955C0160A070
C965	700	1450	4.3	105	165	1.2	0.7	X	—	B59965C0160A070
C975	550	1100	3.0	85	135	1.8	1.1	X	—	B59975C0160A070
C985	300	600	1.0	65	100	4.6	2.7	X	X	B59985C0160A070
C995	150	300	0.7	40	65	13	7.8	X	X	B59995C0160A070

### Reliability data

Test	Standard	Test conditions	$ \Delta R_{25}/R_{25} $
Electrical endurance, cycling	IEC 60738-1	Room temperature, $I_{Smax}$ , $V_{max}$ Number of cycles: 100	< 25%
Electrical endurance, constant	IEC 60738-1	Storage at $V_{max}/T_{op,max}$ ( $V_{max}$ ) Test duration: 1000 h	< 25%
Damp heat	IEC 60738-1	Temperature of air: 40 °C Relative humidity of air: 93% Duration: 56 days Test according to IEC 60068-2-78	< 10%
Rapid change of temperature	IEC 60738-1	$T_1 = T_{op,min}$ (0 V), $T_2 = T_{op,max}$ (0 V) Number of cycles: 5 Test duration: 30 min Test according to IEC 60068-2-14, Test Na	< 10%
Vibration	IEC 60738-1	Frequency range: 10 to 55 Hz Displacement amplitude: 0.75 mm Test duration: 3 × 2 h Test according to IEC 60068-2-6, Test Fc	< 5%
Shock	IEC 60738-1	Acceleration: 390 m/s <sup>2</sup> Pulse duration: 6 ms; 6 × 4000 pulses	< 5%
Climatic sequence	IEC 60738-1	Dry heat: $T = T_{op,max}$ (0 V) Test duration: 16 h Damp heat first cycle Cold: $T = T_{op,min}$ (0 V) Test duration: 2 h Damp heat 5 cycles Tests performed according to IEC 60068-2-30	< 10%

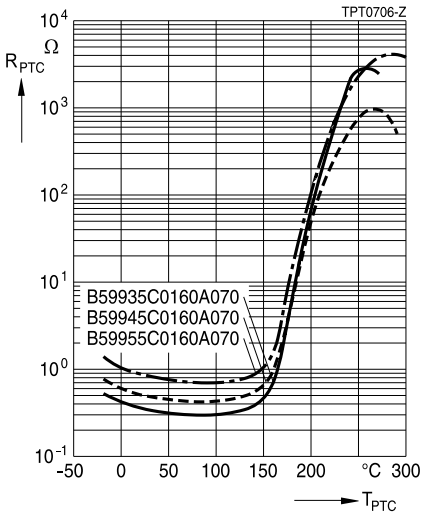
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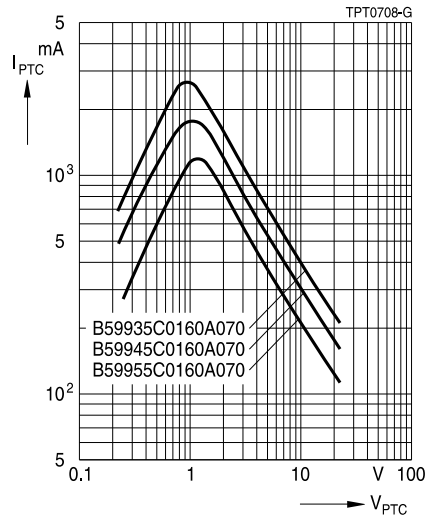
C935 ... C995

### Characteristics (typical)

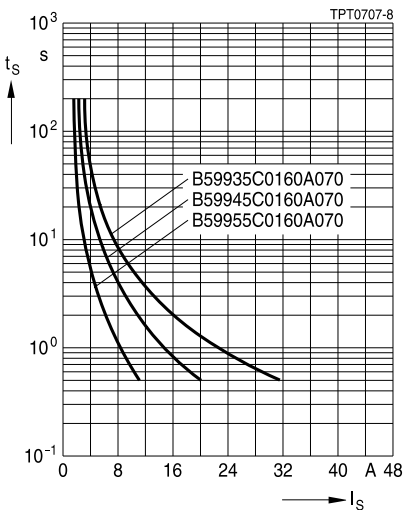
PTC resistance  $R_{PTC}$  versus  
PTC temperature  $T_{PTC}$   
(measured at low signal voltage)



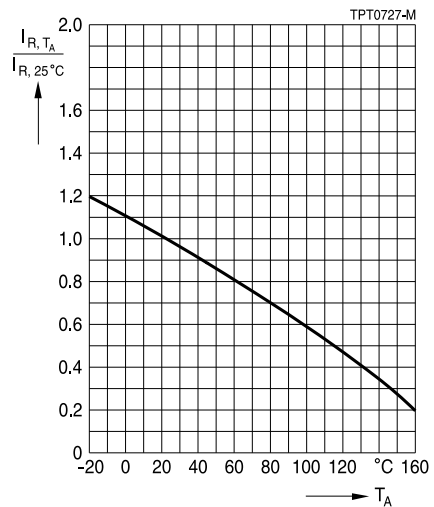
PTC current  $I_{PTC}$  versus PTC voltage  $V_{PTC}$   
(measured at 25 °C in still air)



Switching time  $t_s$  versus switching current  $I_s$   
(measured at 25 °C in still air)

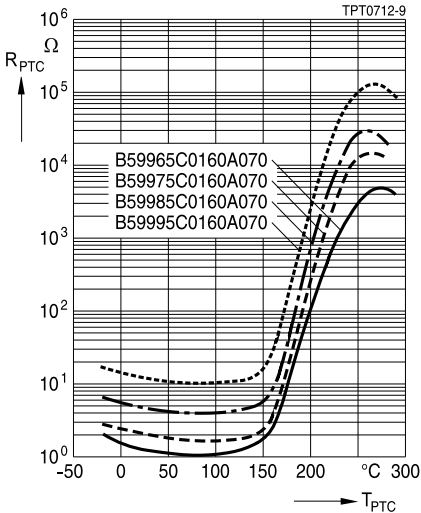


Rated current  $I_R$  versus ambient temperature  $T_A$   
(measured in still air)

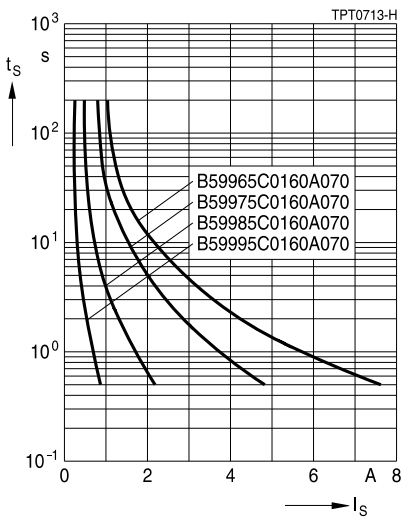


**Characteristics (typical)**

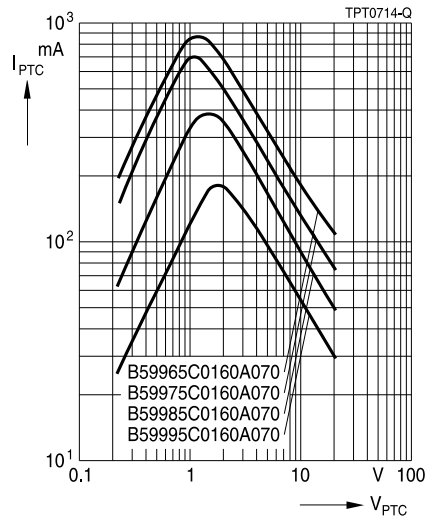
PTC resistance  $R_{PTC}$  versus  
PTC temperature  $T_{PTC}$   
(measured at low signal voltage)



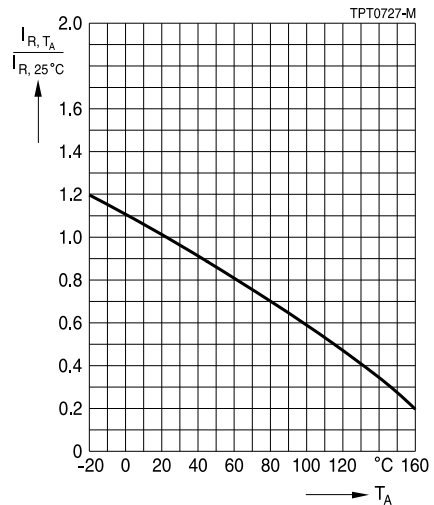
Switching time  $t_s$  versus switching current  $I_s$   
(measured at 25 °C in still air)



PTC current  $I_{PTC}$  versus PTC voltage  $V_{PTC}$   
(measured at 25 °C in still air)



Rated current  $I_R$  versus ambient temperature  $T_A$   
(measured in still air)



## **Cautions and warnings**

### **General**

- EPCOS thermistors are designed for specific applications and should not be used for purposes not identified in our specifications, application notes and data books unless otherwise agreed with EPCOS during the design-in-phase.
- Ensure suitability of thermistor through reliability testing during the design-in phase. The thermistors should be evaluated taking into consideration worst-case conditions.

### **Storage**

- Store thermistors only in original packaging. Do not open the package before storage.
- Storage conditions in original packaging: storage temperature  $-25\text{ }^{\circ}\text{C} \dots +45\text{ }^{\circ}\text{C}$ , relative humidity  $\leq 75\%$  annual mean, maximum 95%, dew precipitation is inadmissible.
- Avoid contamination of thermistors surface during storage, handling and processing.
- Avoid storage of thermistor in harmful environment with effect on function on long-term operation (examples given under operation precautions).
- Use thermistor within the following period after delivery:
  - Through-hole devices (housed and leaded PTCs): 24 months
  - Motor protection sensors, glass-encapsulated sensors and probe assemblies: 24 months
  - Telecom pair and quattro protectors (TPP, TQP): 24 months
  - Leadless PTC thermistors for pressure contacting: 12 months
  - Leadless PTC thermistors for soldering: 6 months
  - SMDs in EIA sizes 3225 and 4032, and for PTCs with metal tags: 24 months
  - SMDs in EIA sizes 0402, 0603, 0805 and 1210: 12 months

### **Handling**

- PTCs must not be dropped. Chip-offs must not be caused during handling of PTCs.
- Components must not be touched with bare hands. Gloves are recommended.
- Avoid contamination of thermistor surface during handling.

### **Soldering (where applicable)**

- Use rosin-type flux or non-activated flux.
- Insufficient preheating may cause ceramic cracks.
- Rapid cooling by dipping in solvent is not recommended.
- Complete removal of flux is recommended.
- Standard PTC heaters are not suitable for soldering.

### **Mounting**

- Electrode must not be scratched before/during/after the mounting process.
- Contacts and housing used for assembly with thermistor have to be clean before mounting. Especially grease or oil must be removed.
- When PTC thermistors are encapsulated with sealing material, the precautions given in chapter "Mounting instructions", "Sealing and potting" must be observed.
- When the thermistor is mounted, there must not be any foreign body between the electrode of the thermistor and the clamping contact.
- The minimum force of the clamping contacts pressing against the PTC must be 10 N.
- During operation, the thermistor's surface temperature can be very high. Ensure that adjacent components are placed at a sufficient distance from the thermistor to allow for proper cooling at the thermistors.
- Ensure that adjacent materials are designed for operation at temperatures comparable to the surface temperature of thermistor. Be sure that surrounding parts and materials can withstand this temperature.
- Avoid contamination of thermistor surface during processing.

### **Operation**

- Use thermistors only within the specified temperature operating range.
- Use thermistors only within the specified voltage and current ranges.
- Environmental conditions must not harm the thermistors. Use thermistors only in normal atmospheric conditions. Avoid use in deoxidizing gases (chlorine gas, hydrogen sulfide gas, ammonia gas, sulfuric acid gas etc), corrosive agents, humid or salty conditions. Contact with any liquids and solvents should be prevented.
- Be sure to provide an appropriate fail-safe function to prevent secondary product damage caused by abnormal function (e.g. use VDR for limitation of overvoltage condition).

**Symbols and terms**

A	Area
$C_{th}$	Heat capacity
f	Frequency
I	Current
$I_{max}$	Maximum current
$I_R$	Rated current
$I_{PTC}$	PTC current
$I_r$	Residual current
$I_{r,oil}$	Residual current in oil (for level sensors)
$I_{r,air}$	Residual current in air (for level sensors)
$I_{RMS}$	Root-mean-square value of current
$I_S$	Switching current
$I_{Smax}$	Maximum switching current
LCT	Lower category temperature
N	Number (integer)
$N_c$	Operating cycles at $V_{max}$ , charging of capacitor
$N_f$	Switching cycles at $V_{max}$ , failure mode
P	Power
$P_{25}$	Maximum power at 25 °C
$P_{el}$	Electrical power
$P_{diss}$	Dissipation power
$R_G$	Generator internal resistance
$R_{min}$	Minimum resistance
$R_R$	Rated resistance
$\Delta R_R$	Tolerance of $R_R$
$R_P$	Parallel resistance
$R_{PTC}$	PTC resistance
$R_{ref}$	Reference resistance
$R_S$	Series resistance
$R_{25}$	Resistance at 25 °C
$R_{25,match}$	Resistance matching per reel/ packing unit at 25 °C
$\Delta R_{25}$	Tolerance of $R_{25}$
T	Temperature
t	Time
$T_A$	Ambient temperature
$t_a$	Thermal threshold time
$T_C$	Ferroelectric Curie temperature



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$t_E$	Settling time (for level sensors)
$T_R$	Rated temperature
$T_{sense}$	Sensing temperature
$T_{op}$	Operating temperature
$T_{PTC}$	PTC temperature
$t_R$	Response time
$T_{ref}$	Reference temperature
$T_{Rmin}$	Temperature at minimum resistance
$t_S$	Switching time
$T_{surf}$	Surface temperature
UCT	Upper category temperature
$V$ or $V_{el}$	Voltage (with subscript only for distinction from volume)
$V_{RMS}$	Root-mean-square value of voltage
$V_{BD}$	Breakdown voltage
$V_{ins}$	Insulation test voltage
$V_{link,max}$	Maximum link voltage
$V_{max}$	Maximum operating voltage
$V_{max,dyn}$	Maximum dynamic (short-time) operating voltage
$V_{meas}$	Measuring voltage
$V_{meas,max}$	Maximum measuring voltage
$V_R$	Rated voltage
$V_{PTC}$	Voltage drop across a PTC thermistor
$\alpha$	Temperature coefficient
$\Delta$	Tolerance, change
$\delta_{th}$	Dissipation factor
$\tau_{th}$	Thermal cooling time constant
$\lambda$	Failure rate
$e$	Lead spacing (in mm)

## Abbreviations / Notes

**SMD** Surface-mount devices

\* To be replaced by a number in ordering codes, type designations etc.

+ To be replaced by a letter

All dimensions are given in mm.

The commas used in numerical values denote decimal points.

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